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Youichi KUKIMOTO	HARIMA CHEMICALS, INC.,
Hitoshi SAKURAI	671-4, Mizuashi, Noguchi-cho, Kakogawa-shi, Hyogo 675-0019,
Seishi KUMAMOTO Kenshu OYAMA	JAPAN
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Additional name(s) of conveying party(ies) attached? \(\begin{align*} \text{Yes} & \overline{\sigma} \text{No} \end{align*}	7
3. Nature of conveyance:	22278 U.S. PT 10/765931
☑ Assignment ☐ Merger	122
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Execution Date: December 8, 2004	Additional name(s) & address(es) attached? ☐ Yes ☑ No
4. Application number(s) or patent number(s):	Additional name(s) & address(cs) attached: 11 Tes 12 No
If this document is being filed together with a new application, the execution date of the application is: December 8, 2003	
A. Patent Application No.(s)	B. Patent No.(s)
107765 931	B. Tatent (vo.(s)
101165 131	
Additional numbers attached?	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
SUGHRUE MION, PLLC	7. Total fee (37 CFR 3.41): \$40.00
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**PATENT REEL: 014944 FRAME: 0274** 

## **Assignment**

Whereas, I/We, Youichi KUKIMOTO, Hitoshi SAKURAI, Seishi KUMAMOTO and Kenshu OYAMA of (c/o) Harima Chemicals, Inc., 671-4, Mizuashi, Noguchi-cho, Kakogawashi, Hyogo 675-0019, JAPAN hereinafter called assignor(s), have invented certain improvements in Solder Deposition Method and Solder Bump Forming Method and executed an application for Letters Patent of the United States of America therefor on Whereas, Harima Chemicals, Inc. of 671-4, Mizuashi, Noguchi-cho, Kakogawa-shi, Hyogo 675-0019, JAPAN (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor; Now therefore, for valuable consideration, receipt whereof is hereby acknowledged, I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. §119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee. I/We hereby authorize and request our attorneys SUGHRUE MION, PLLC of 2100 Pennsylvania Avenue, NW, Washington, DC 20037-3213 to insert here in parentheses \_\_\_\_\_ and Confirmation number (Application number \_\_\_\_\_ \_\_, filed ) the application number and filing date of said application when known. 12/08/2003 Yourchi Kukimoto

12/08/2003 Hiroshi Sakurai

12/08/2003 Seishi Kumamoto

12/08/2003 Kenshu Ogama

12/08/2003 Kenshu Ogama

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. §261)

RECORDED: 01/29/2004

PATENT REEL: 014944 FRAME: 0275